## SN65LBC173A, SN75LBC173A QUADRUPLE RS-485 DIFFERENTIAL LINE RECEIVERS

SLLS456A - NOVEMBER 2000 - REVISED FEBRUARY 2001

- Designed for TIA/EIA-485, TIA/EIA-422, and ISO 8482 Applications
- Signaling Rate<sup>†</sup> Exceeding 50 Mbps
- Fail-Safe in Bus Short-Circuit, Open-Circuit, and Idle-Bus Conditions
- ESD Protection on Bus Inputs Exceeds 6 kV
- Common-Mode Bus Input Range
   -7 V to 12 V
- Propagation Delay Times <16 ns</li>
- Low Standby Power Consumption <20 μA</li>
- Pin-Compatible Upgrade for AM26LS32, DS96F173, LTC488, and SN75173

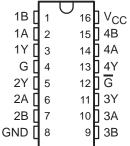
#### description

The SN65LBC173A and SN75LBC173A are quadruple differential line receivers with 3-state outputs, designed for TIA/EIA-485 (RS-485), TIA/EIA-422 (RS-422), and ISO 8482 (Euro RS-485) applications.

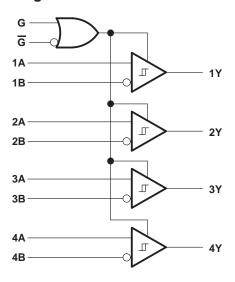
These devices are optimized for balanced multipoint bus communication at data rates up to and exceeding 50 million bits per second. The transmission media may be twisted-pair cables, printed-circuit board traces, or backplanes. The ultimate rate and distance of data transfer is dependent upon the attenuation characteristics of the media and the noise coupling to the environment.

SN65LBC173A (Marked as 65LBC173A)
SN75LBC173A (Marked as 75LBC173A)
D or N PACKAGE
(TOP VIEW)

1B 1 16 VCC



#### logic diagram



Each receiver operates over a wide range of positive and negative common-mode input voltages, and features ESD protection to 6 kV, making it suitable for high-speed multipoint data transmission applications in harsh environments. These devices are designed using LinBiCMOS™, facilitating low power consumption and robustness.

The G and  $\overline{G}$  inputs provide enable control logic for either positive- or negative-logic enabling all four drivers. When disabled or powered off, the receiver inputs present a high-impedance to the bus for reduced system loading.

The SN75LBC173A is characterized for operation over the temperature range of 0°C to 70°C. The SN65LBC173A is characterized over the temperature range from –40°C to 85°C.



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LinBiCMOS is a trademark of Texas Instruments.

†The signaling rate of a line is the number of voltage transitions that are made per second expressed in the units bps (bits per second).



# FUNCTION TABLE (each receiver)

DIFFERENTIAL INPUTS	ENA	OUTPUT	
A – B (V <sub>ID</sub> )	G	G	Υ
V- < 0.0V	Н	Х	
V <sub>ID</sub> ≤ -0.2 V	Х	L	L
0.01/ 1/ 0.041/	Н	Х	2
-0.2 V < V <sub>ID</sub> < -0.01 V	Х	L	?
0.04.1/ < 1/	Н	Х	
–0.01 V ≤ V <sub>ID</sub>	Х	L	Н
V	L	Н	7
X	OPEN	OPEN	Z
Ch ant ainsuit	Н	Х	
Short circuit	Х	L	Н
Open circuit	Н	Х	Н

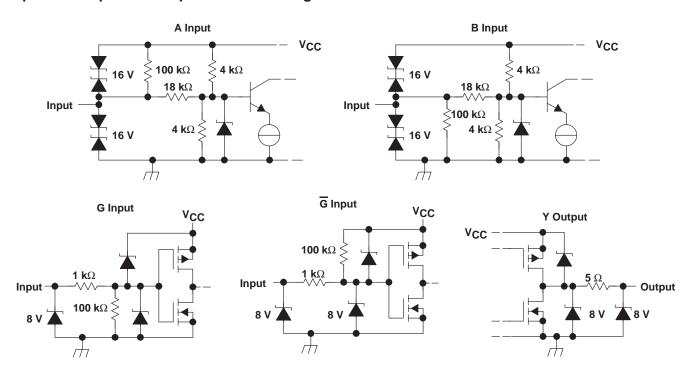
 $H = high \ level, \quad L = low \ level, \quad X = irrelevant, \quad Z = high \ impedance (off),$ ? = indeterminate

#### **AVAILABLE OPTIONS**

	PACKAGE			
TA	PLASTIC SMALL OUTLINE† (JEDEC MS-012)	PLASTIC DUAL-IN-LINE (JEDEC MS-001)		
0°C to 70°C	SN75LBC173AD	SN75LBC173AN		
-40°C to 85°C	SN65LBC173AD	SN65LBC173AN		

<sup>†</sup> Add an R suffix for taped and reeled

## equivalent input and output schematic diagrams





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### absolute maximum ratings†

Supply voltage range, V <sub>CC</sub> (see Note 1)		0.3 V to 6 V
Voltage range at any bus input (DC)		
Voltage range at any bus input (transient p	oulse through 100 $\Omega$ , see	Figure 5) –30 V to 30 V
Voltage input range at G and $\overline{G}$ , $V_1$		0.5 V to V <sub>CC</sub> + 0.5 V
Electrostatic discharge:		
Human body model (see Note 2):	A and B to GND	6 kV
	All pins	5 kV
Charged-device model (see Note 3):	All pins	2 kV
Storage temperature range		
Continuous power dissipation		See Power Dissipation Rating Table
Lead temperature 1.6 mm (1/16 inch) from	case for 10 seconds	260°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential I/O bus voltages, are with respect to GND, and are steady-state (unless otherwise specified).

- 2. Tested in accordance with JEDEC Standard 22, Test Method A114-A.
- 3. Tested in accordance with JEDEC Standard 22, Test Method C101.

#### **DISSIPATION RATING TABLE**

PACKAGE	$T_{\mbox{$A$}} \leq 25^{\circ}\mbox{$C$}$ POWER RATING	DERATING FACTOR <sup>‡</sup> ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 70°C POWER RATING	T <sub>A</sub> = 85°C POWER RATING	
D	1080 mW	8.7 mW/°C	690 mW	560 mW	
N	1150 mW	9.2 mW/°C	736 mW	598 mW	

<sup>&</sup>lt;sup>‡</sup> This is the inverse of the junction-to-ambient thermal resistance when board-mounted and with no air flow.

## recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>		4.75	5	5.25	V
Voltage at any bus terminal	A, B	-7		12	V
High-level input voltage, VIH	- <del>-</del>	2		VCC	
Low-level input voltage, V <sub>IL</sub>	G, G			8.0	V
Output current	Υ	-8		8	mA
0	SN75LBC173A	0		70	
Operating free-air temperature, T <sub>A</sub>	SN65LBC173A	-40		85	°C

# SN65LBC173A, SN75LBC173A QUADRUPLE RS-485 DIFFERENTIAL LINE RECEIVERS

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### electrical characteristics over recommended operating conditions

	PARAMETE	R	TEST CO	NDITIONS	MIN	TYP†	MAX	UNIT
V <sub>IT+</sub>	Positive-going differential in	put voltage threshold	777 177 14077			-80	-10	.,
V <sub>IT</sub> _	Negative-going differential i	nput voltage threshold	$-7 \text{ V} \leq \text{V}_{CM} \leq 12 \text{ V}$	$-7 \text{ V} \le \text{V}_{CM} \le 12 \text{ V} (\text{V}_{CM} = (\text{V}_A + \text{V}_B)/2)$		-120		mV
VHYS	Hysteresis voltage (V <sub>IT+</sub> -	V <sub>IT</sub> _)				40		mV
٧ıK	Input clamp voltage		I <sub>I</sub> = -18 mA	I <sub>I</sub> = -18 mA		-0.8		V
Vон	High-level output voltage		V <sub>ID</sub> = 200 mV, I <sub>OH</sub> = -8 mA		2.7	4.8		.,
V <sub>OL</sub>	Low-level output voltage		V <sub>ID</sub> = -200 mV, I <sub>OL</sub> = 8 mA	See Figure 1		0.2	0.4	V
loz	High-impedance-state outp	ut current	$V_O = 0 V \text{ to } V_{CC}$	$V_O = 0 \text{ V to } V_{CC}$			1	μΑ
			Other input at 0 V, VI =	V <sub>I</sub> = 12 V			0.9	
li l	Line input current		$V_{CC} = 0 \text{ V or 5 V}$	V <sub>I</sub> = −7 V	-0.7		mA	
lн	High-level input current	<del>.</del>					100	μΑ
Ι <sub>Ι</sub>	Low-level input current	Enable inputs G, G			-100			μΑ
R <sub>I</sub>	Input resistance	A, B inputs			12			kΩ
	I <sub>CC</sub> Supply current		V <sub>ID</sub> = 5 V	G at 0 V, G at V <sub>CC</sub>			20	μΑ
ICC			No load	G at V <sub>CC</sub> , G at 0 V		11	16	mA

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$  and  $25^{\circ}\text{C}$ .

## switching characteristics over recommended operating conditions

	PARAMETER	TEST CONDITIONS	MIN	TYP <sup>†</sup>	MAX	UNIT
t <sub>r</sub>	Output rise time			2	4	ns
t <sub>f</sub>	Output fall time	)		2	4	ns
<sup>t</sup> PLH	Propagation delay time, low-to-high level output	$V_{ID} = -3 \text{ V to } 3 \text{ V}, \text{ See Figure 2}$	9	12	16	ns
<sup>t</sup> PHL	Propagation delay time, high-to-low level output	]	9	12	16	ns
<sup>t</sup> PZH	Propagation delay time, high-impedance to high-level output	0 5:		27	38	ns
<sup>t</sup> PHZ	Propagation delay time, high-level to high-impedance output	See Figure 3		7	16	ns
tPZL	Propagation delay time, high-impedance to low level output	On a Figure 4		29	38	ns
<sup>t</sup> PLZ	Propagation delay time, low-level to high-impedance output	See Figure 4		12	16	ns
tsk(p)	Pulse skew (  (tpLH - tpHL)  )			0.2	1	ns
tsk(o)	Output skew (see Note 4)				2	ns
tsk(pp)	Part-to-part skew (see Note 5)				2	ns

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$  and  $25^{\circ}\text{C}$ .

NOTES: 4. Outputs skew  $(t_{Sk(0)})$  is the magnitude of the time delay difference between the outputs of a single device with all of the inputs connected together.

5. Part-to-part skew (t<sub>sk(pp)</sub>) is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same input signals, the same supply voltages, at the same temperature, and have identical packages and test circuits.



## PARAMETER MEASUREMENT INFORMATION

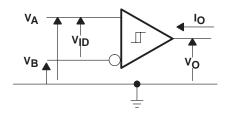


Figure 1. Voltage and Current Definitions

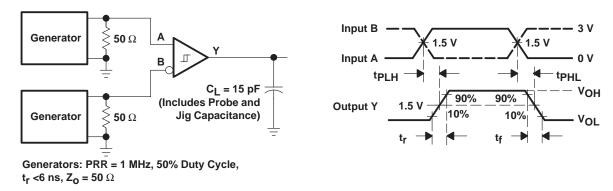


Figure 2. Switching Test Circuit and Waveforms

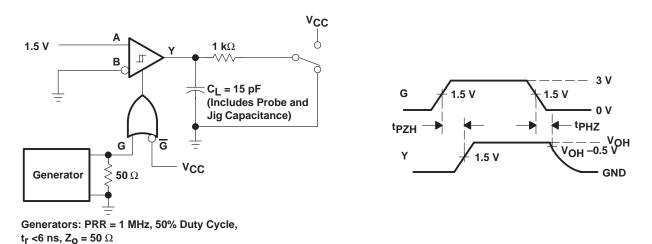
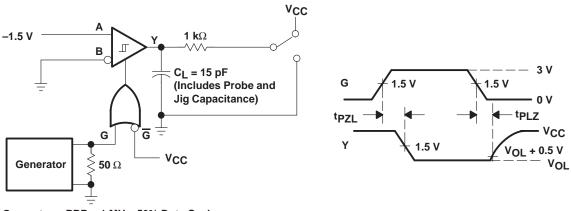


Figure 3. Test Circuit Waveforms, tpZH and tpHZ

#### PARAMETER MEASUREMENT INFORMATION



Generators: PRR = 1 MHz, 50% Duty Cycle,  $t_{T}$  <6 ns,  $Z_{O}$  = 50  $\Omega$ 

Figure 4. Test Circuit Waveforms, tpZL and tpLZ

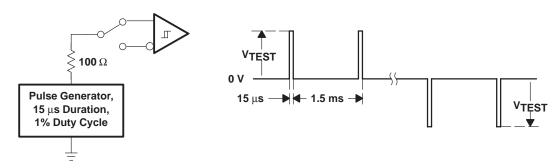
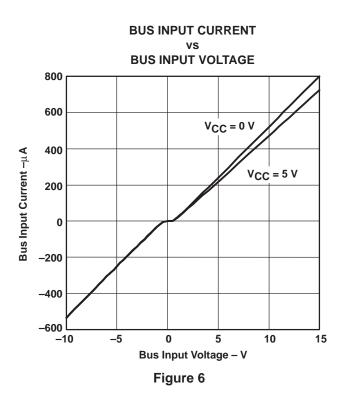
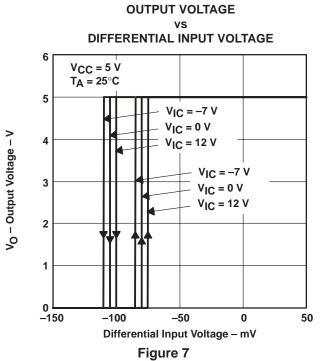
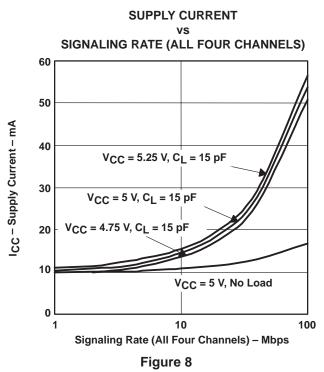


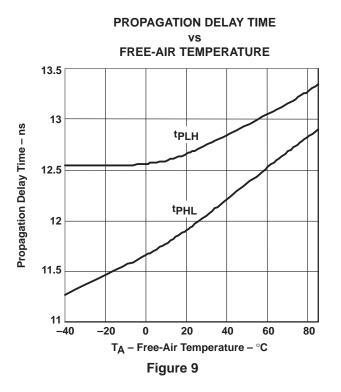
Figure 5. Test Circuit and Waveform, Transient Over-Voltage Test

#### TYPICAL CHARACTERISTICS









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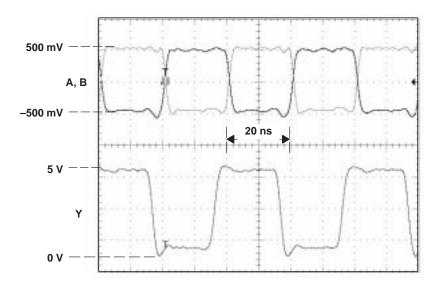


Figure 10. Receiver Inputs and Outputs, 50 Mbps Signaling Rate

#### **APPLICATION INFORMATION**

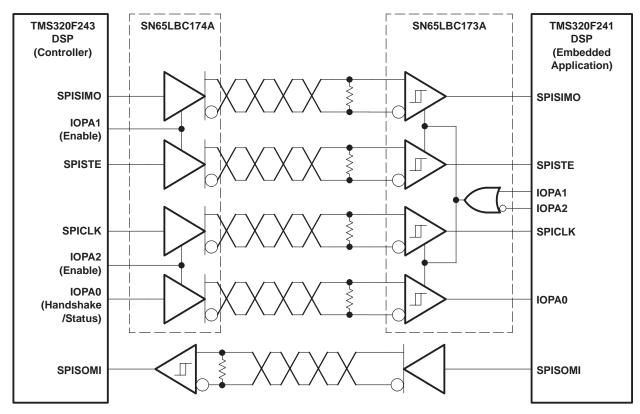


Figure 11. Typical Application Circuit, DSP-to-DSP Link via Serial Peripheral Interface

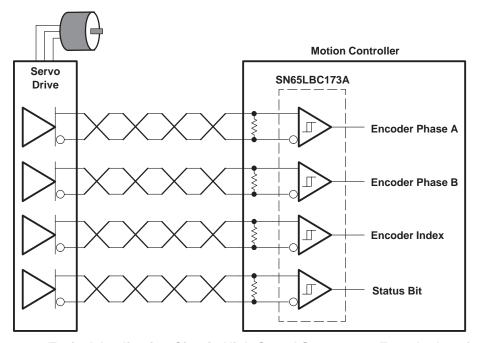


Figure 12. Typical Application Circuit, High-Speed Servomotor Encoder Interface



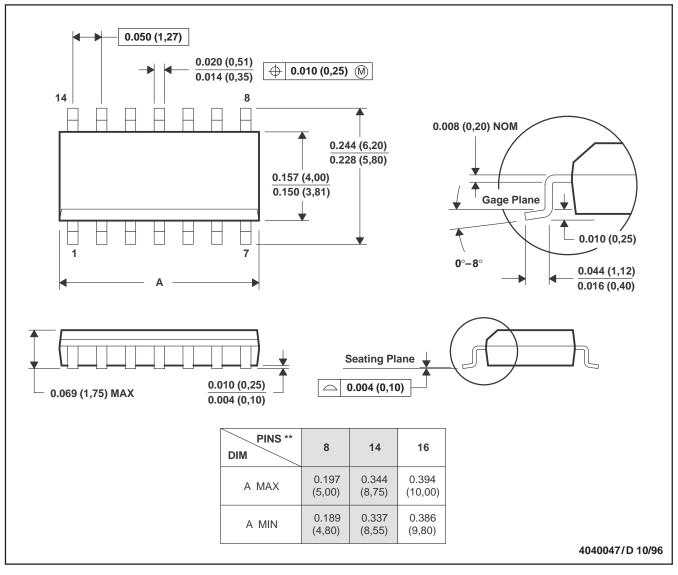
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#### **MECHANICAL DATA**

#### D (R-PDSO-G\*\*)

#### 14 PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012

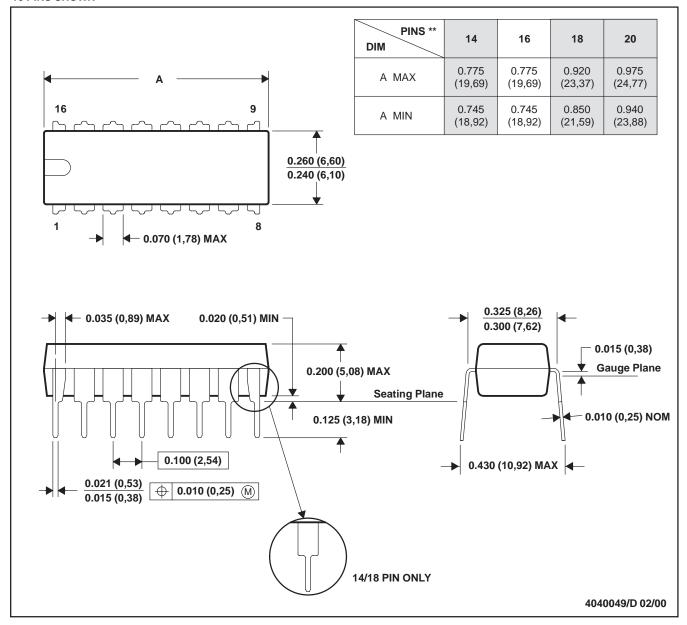
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#### **MECHANICAL DATA**

#### N (R-PDIP-T\*\*)

#### **16 PINS SHOWN**

#### PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 (20-pin package is shorter than MS-001).

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